RENESAS HD74LV1G32A

2-input OR Gate

REJ03D0068-0600Z (Previous ADE-205-321D (Z)) Rev.6.00 Aug.29.2003

Description

The HD74LV1G32A has two–input OR gate in a 5 pin package. Low voltage and high-speed operation is suitable for the battery powered products (e.g., notebook computers), and the low power consumption extends the battery life.

Features

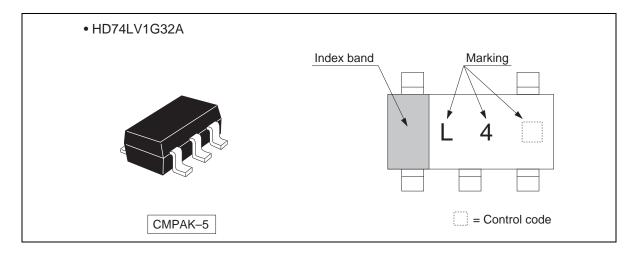
- The basic gate function is lined up as Renesas uni logic series.
- Supplied on emboss taping for high-speed automatic mounting.
- Electrical characteristics equivalent to the HD74LV32A Supply voltage range : 1.65 to 5.5 V Operating temperature range : -40 to +85°C
- All inputs V_{IH} (Max.) = 5.5 V (@V_{CC} = 0 V to 5.5 V) All outputs V₀ (Max.) = 5.5 V (@V_{CC} = 0 V)
- Output current $\pm 6 \text{ mA}$ (@V_{CC} = 3.0 V to 3.6 V), $\pm 12 \text{ mA}$ (@V_{CC} = 4.5 V to 5.5 V)
- All the logical input has hysteresis voltage for the slow transition.
- Ordering Information

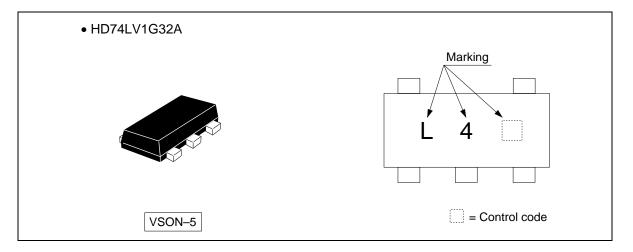
Part Name	Package Type	Package Code	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LV1G32ACME	CMPAK–5 pin	CMPAK-5V	СМ	E (3,000 pcs/reel)
		CMPAK-5V(O)	_	
HD74LV1G32AVSE	VSON–5 pin	TNP-5DV	VS	

Note: Please consult the sales office for the above package availability.



Outline and Article Indication





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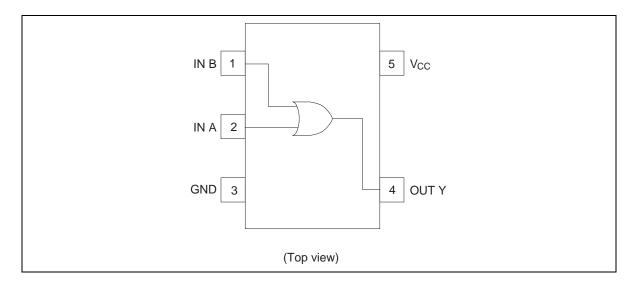


Function Table

Inputs		Output Y
Α	В	
L	L	L
Н	L	Н
L	Н	Н
Н	Н	Н
H : High level		

L : Low level

Pin Arrangement



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Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Test Conditions
Supply voltage range	V _{CC}	–0.5 to 7.0	V	
Input voltage range *1	VI	-0.5 to 7.0	V	
Output voltage range *1, 2	Vo	-0.5 to V _{CC} + 0.5	V	Output : H or L
		-0.5 to 7.0		V _{CC} : OFF
Input clamp current	I _{IK}	-20	mA	V ₁ < 0
Output clamp current	l _{ок}	±50	mA	$V_{\rm O}$ < 0 or $V_{\rm O}$ > $V_{\rm CC}$
Continuous output current	lo	±25	mA	$V_{O} = 0$ to V_{CC}
Continuous current through V_{CC} or GND	I_{CC} or I_{GND}	±50	mA	
Maximum power dissipation at Ta = 25° C (in still air) ^{*3}	P _T	200	mW	
Storage temperature	Tstg	–65 to 150	°C	

Notes: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore no two of which may be realized at the same time.

1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

2. This value is limited to 5.5 V maximum.

3. The maximum package power dissipation was calculated using a junction temperature of 150°C.



Item	Symbol	Min	Max	Unit	Conditions
Supply voltage range	V _{CC}	1.65	5.5	V	
Input voltage range	VI	0	5.5	V	
Output voltage range	Vo	0	Vcc	V	
Output current	I _{OL}	_	1	mA	V_{CC} = 1.65 to 1.95 V
		_	2		V_{CC} = 2.3 to 2.7 V
		_	6		V_{CC} = 3.0 to 3.6 V
		_	12		$V_{CC} = 4.5$ to 5.5 V
	I _{OH}	_	-1		V_{CC} = 1.65 to 1.95 V
		_	-2		V_{CC} = 2.3 to 2.7 V
		_	-6		V_{CC} = 3.0 to 3.6 V
		_	-12		V_{CC} = 4.5 to 5.5 V
Input transition rise or fall rate	Δt / Δv	0	300	ns / V	V_{CC} = 1.65 to 1.95 V
		0	200		V_{CC} = 2.3 to 2.7 V
		0	100		V_{CC} = 3.0 to 3.6 V
		0	20		V_{CC} = 4.5 to 5.5 V
Operating free-air temperature	T _a	-40	85	°C	

Recommended Operating Conditions

Note: Unused or floating inputs must be held high or low.

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Electrical Characteristic

• Ta = -40 to $85^{\circ}C$

Item	Symbol	Vcc (V) *	Min	Тур	Max	Unit	Test condition
Input voltage	V _{IH}	1.65 to 1.95	V _{CC} ×0.75	_	_	V	
		2.3 to 2.7	V _{CC} ×0.7	_	—	-	
		3.0 to 3.6	V _{CC} ×0.7	_	_	-	
		4.5 to 5.5	V _{CC} ×0.7	—	_	-	
	V _{IL}	1.65 to 1.95	—	—	V _{CC} ×0.25	-	
		2.3 to 2.7	—	—	V _{CC} ×0.3	-	
		3.0 to 3.6	—	—	V _{CC} ×0.3	-	
		4.5 to 5.5	—	—	V _{CC} ×0.3	-	
Hysteresis voltage	V _H	1.8	_	0.25		V	$V_T^+ - V_T^-$
		2.5	_	0.30	_	-	
		3.3	—	0.35	_	-	
		5.0	_	0.45	_	-	
Output voltage	V _{OH}	Min to Max	V _{CC} -0.1	—	_	V	I _{OH} = -50 μA
		1.65	1.4	—	_	-	$I_{OH} = -1 \text{ mA}$
		2.3	2.0	_		-	$I_{OH} = -2 \text{ mA}$
		3.0	2.48	—	_	-	I _{OH} = -6 mA
		4.5	3.8	_	_	-	I _{OH} = -12 mA
	Vol	Min to Max	—	_	0.1	-	I _{OL} = 50 μA
		1.65	—	_	0.3	-	I _{OL} = 1 mA
		2.3	—	_	0.4	-	$I_{OL} = 2 \text{ mA}$
		3.0	_	_	0.44	-	I _{OL} = 6 mA
		4.5	_	_	0.55	-	I _{OL} = 12 mA
Input current	I _{IN}	0 to 5.5	—	—	±1	μΑ	V_{IN} = 5.5 V or GND
Quiescent supply current	Icc	5.5	—	—	10	μA	$V_{IN} = V_{CC}$ or GND, $I_O = 0$
Output leakage current	I _{OFF}	0	_	—	5	μA	V_{IN} or $V_O = 0$ to 5.5 V
Input capacitance	CIN	3.3	_	2.5	_	pF	$V_{IN} = V_{CC} \text{ or } GND$

Note: For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.

Switching Characteristics

• $V_{CC} = 1.8 \pm 0.15 \text{ V}$

ltem	Symbol	Ta = 2	25°C	Ta = -40 to 85°C		Unit		FROM	то	
		Min	Тур	Max	Min	Max	-	Conditions	(Input)	(Output)
Propagation	t _{PLH}	—	12.3	22.5	1.0	25.0	ns	$C_L = 15 \text{ pF}$	A or B	Y
delay time	t _{PHL}	_	17.7	31.0	1.0	34.0		$C_L = 50 \text{ pF}$	_	

• $V_{CC} = 2.5 \pm 0.2 \text{ V}$

ltem	Symbol	Ta = 2	25°C	Ta = -40 to 85°C		Unit		FROM	ТО	
		Min	Тур	Max	Min	Max		Conditions	(Input)	(Output)
Propagation	t _{PLH}	_	7.1	12.8	1.0	15.0	ns	$C_L = 15 \text{ pF}$	A or B	Y
delay time	t _{PHL}	_	9.6	16.2	1.0	19.0	_	$C_L = 50 \text{ pF}$	_	

• $V_{CC} = 3.3 \pm 0.3 V$

ltem	Symbol	Ta = 2	25°C	Ta = -40 to 85°C		Unit		FROM	ТО	
		Min	Тур	Max	Min	Max	-	Conditions	(Input)	(Output)
Propagation	t _{PLH}	_	5.0	7.9	1.0	9.5	ns	$C_L = 15 \text{ pF}$	A or B	Y
delay time	t _{PHL}	_	6.9	11.4	1.0	13.0	_	$C_L = 50 \text{ pF}$	_	

• $V_{CC} = 5.0 \pm 0.5 \text{ V}$

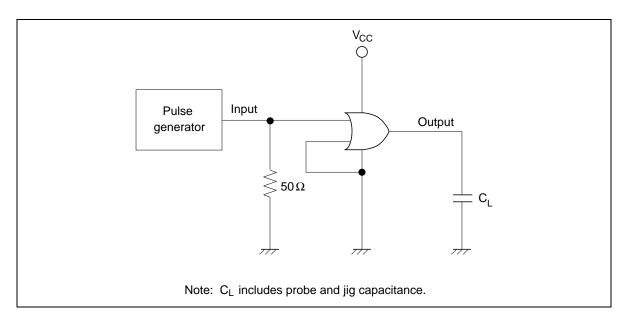
ltem	Symbol	Ta = 2	25°C		Ta = -40 to 85°C		Unit		FROM	то
		Min	Тур	Max	Min	Max		Conditions	(Input)	(Output)
Propagation	t _{PLH}	_	3.6	5.5	1.0	6.5	ns	$C_L = 15 \text{ pF}$	A or B	Y
delay time	t _{PHL}	_	4.9	7.5	1.0	8.5	_	$C_L = 50 \text{ pF}$	_	

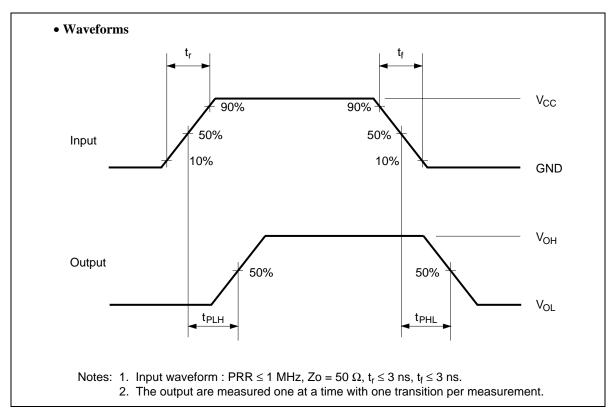
Operating Characteristics

• $C_L = 50 \text{ pF}$

Item	Symbol	V _{cc} (V)	Ta = 25°C			Unit	Test Conditions
			Min	Тур	Max		
Power dissipation	C _{PD}	3.3	_	9.5	_	pF	f = 10 MHz
capacitance		5.0	_	11.5			

Test Circuit

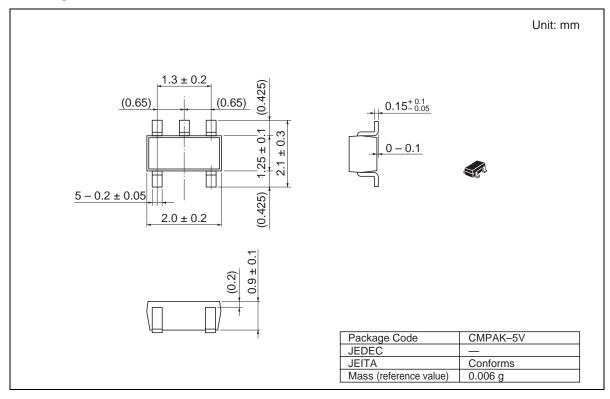


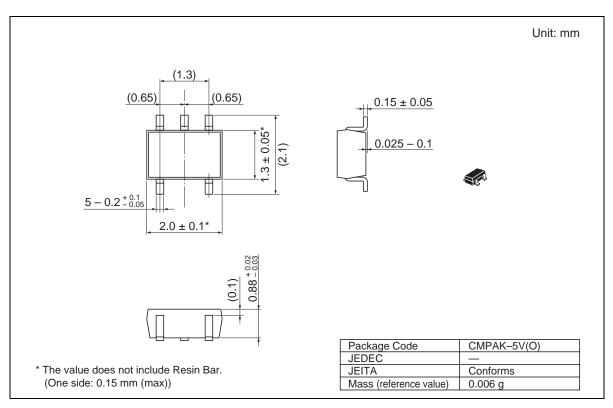


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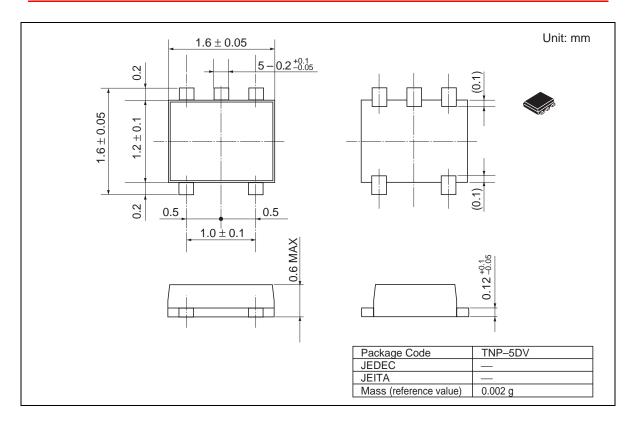
Package Dimensions





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